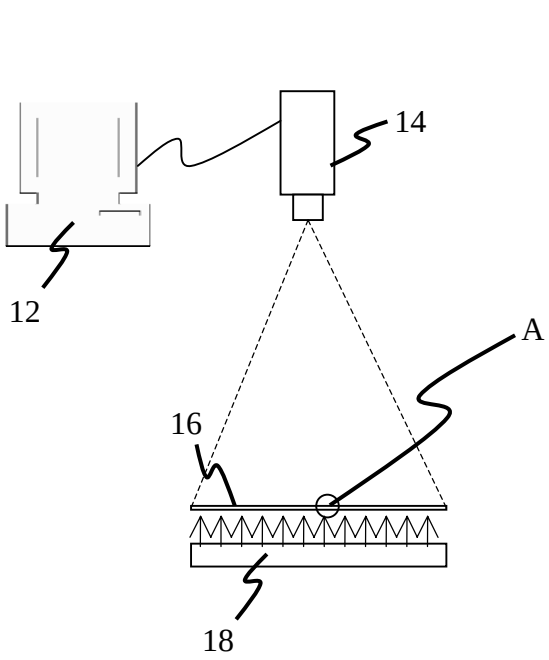


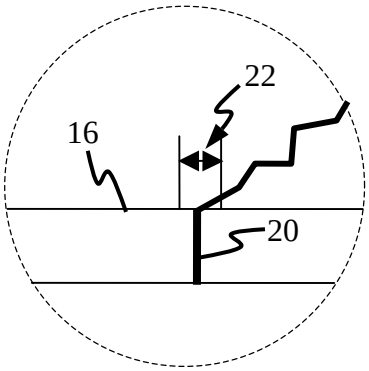


Fig. 1b

Fig. 1a

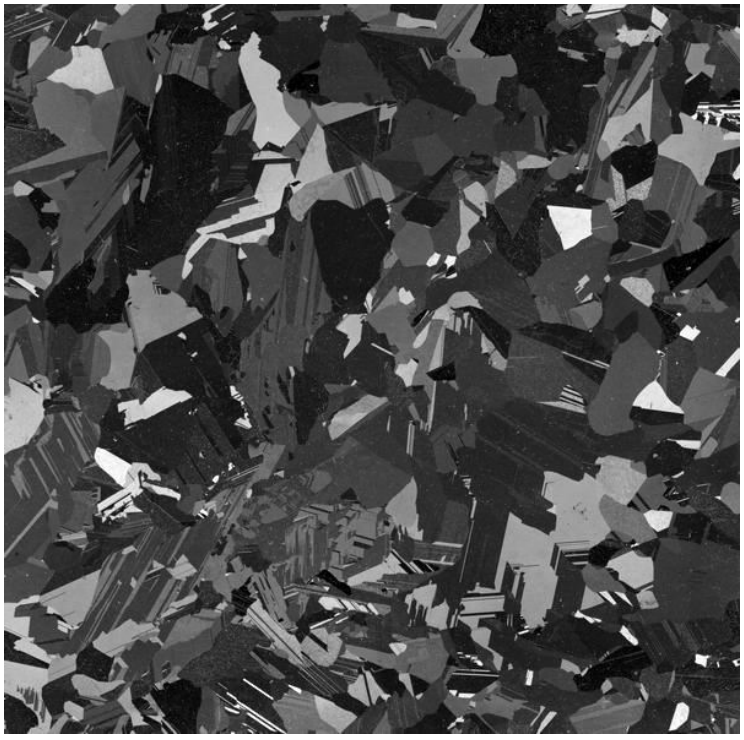


Fig. 2

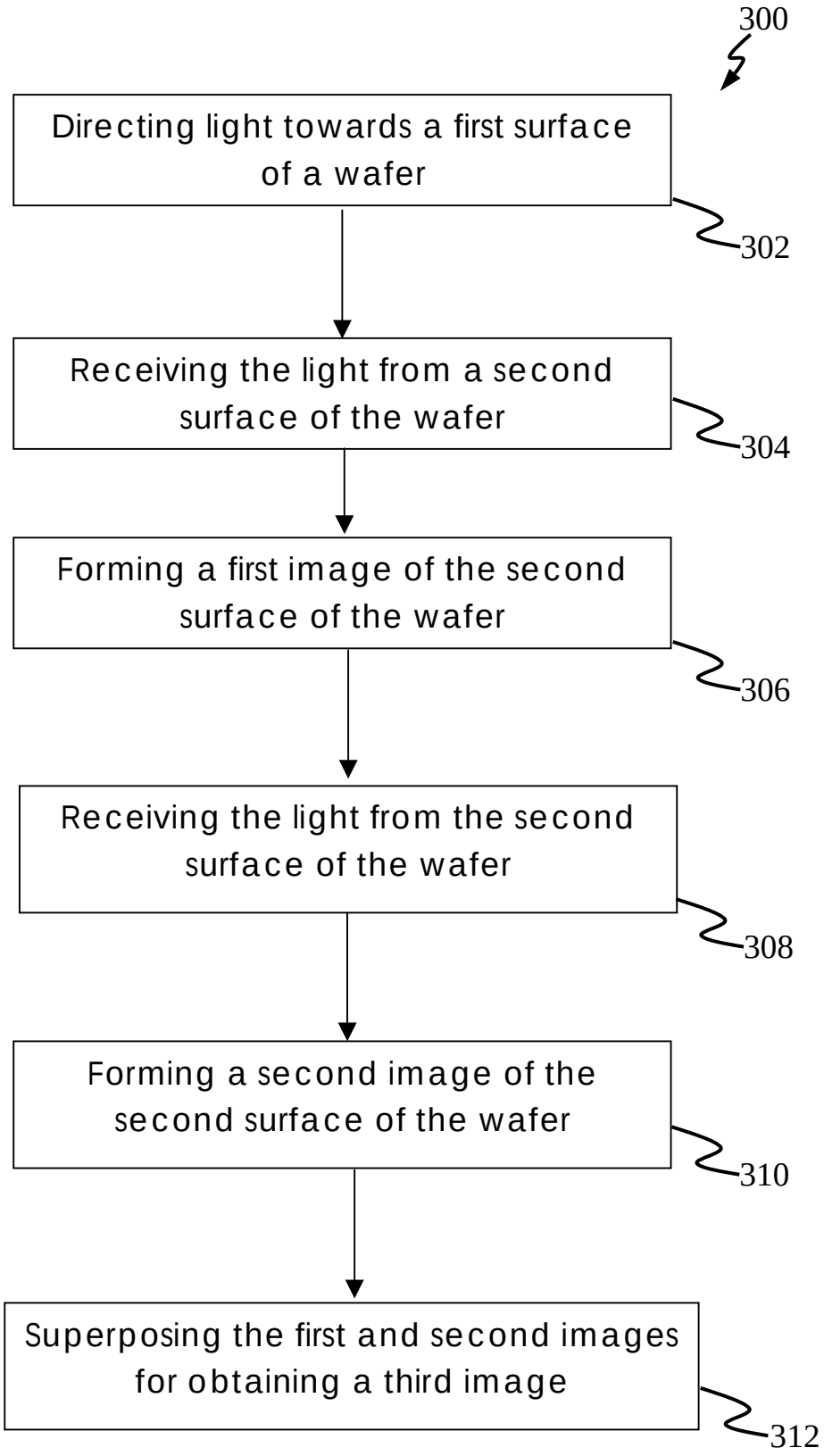

300
Directing light towards a first surface of a wafer
302
Receiving the light from a second surface of the wafer
304
Forming a first image of the second surface of the wafer
306
Receiving the light from the second surface of the wafer
308
Forming a second image of the second surface of the wafer
310
Superposing the first and second images for obtaining a third image
312

Fig. 3

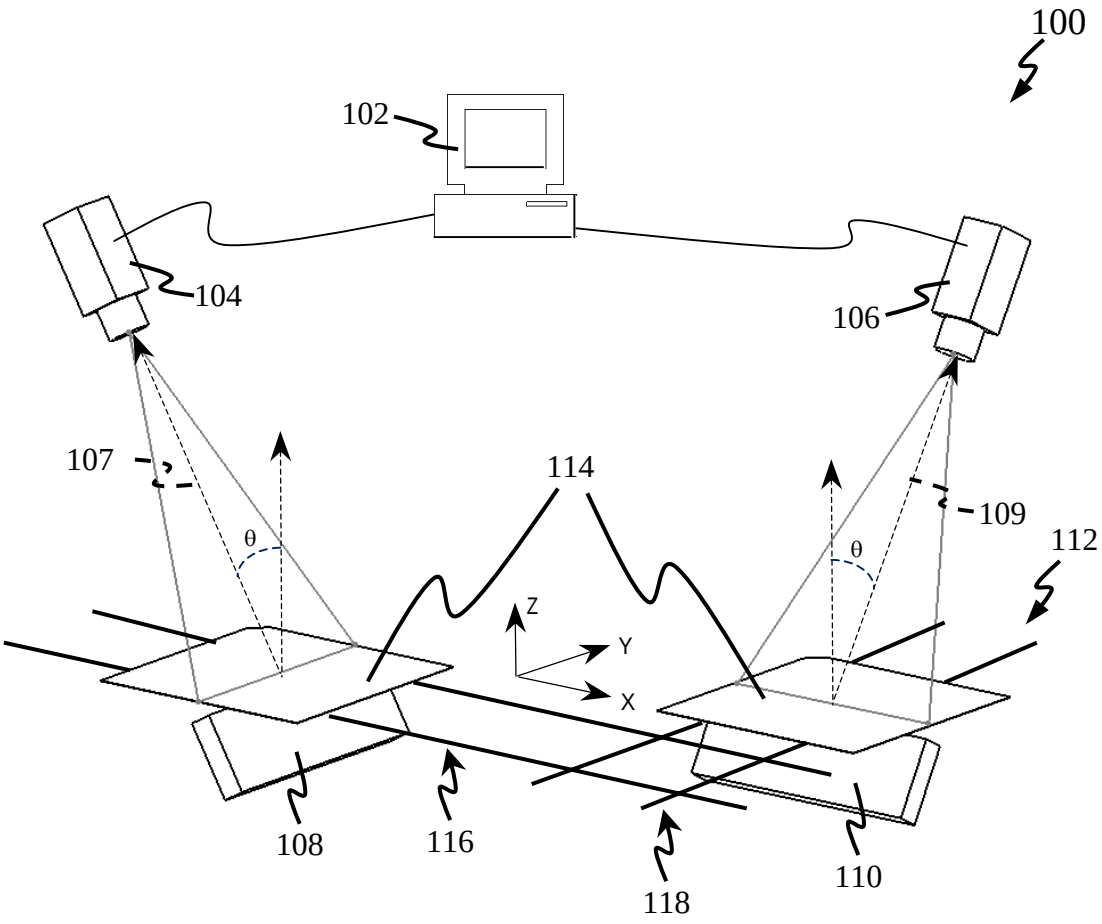


Fig. 4

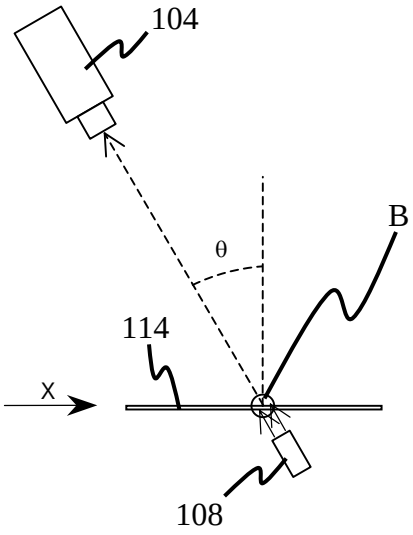


Fig. 5a

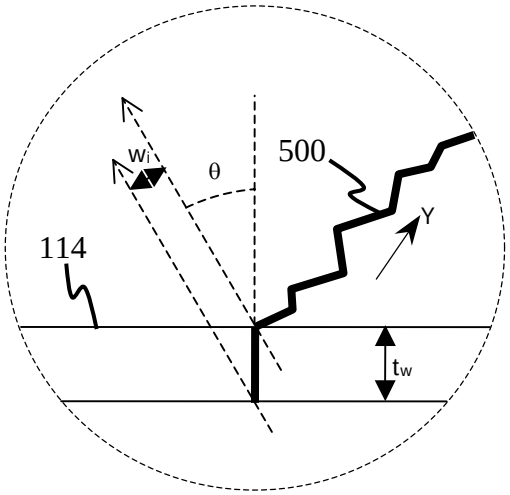


Fig. 5b

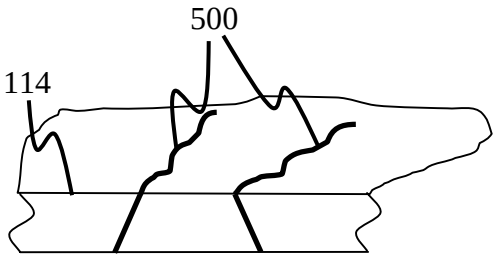


Fig. 5c



Fig. 6a



Fig. 6b

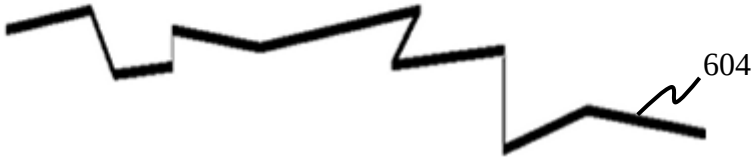


Fig. 6c

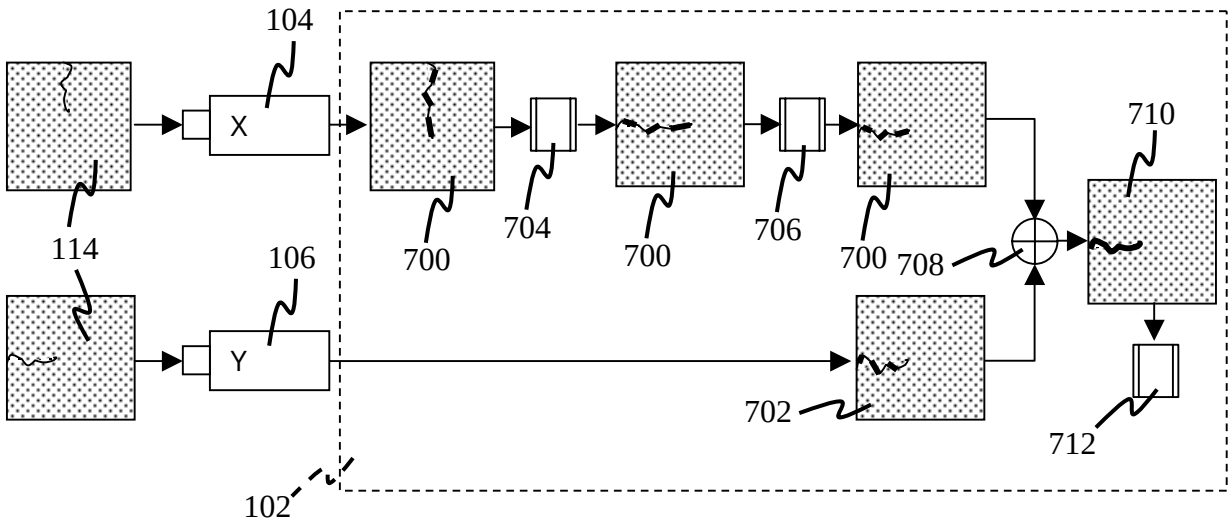

104
X
114
106
Y
700
704
700
706
700
708
710
702
712
102

Fig. 7

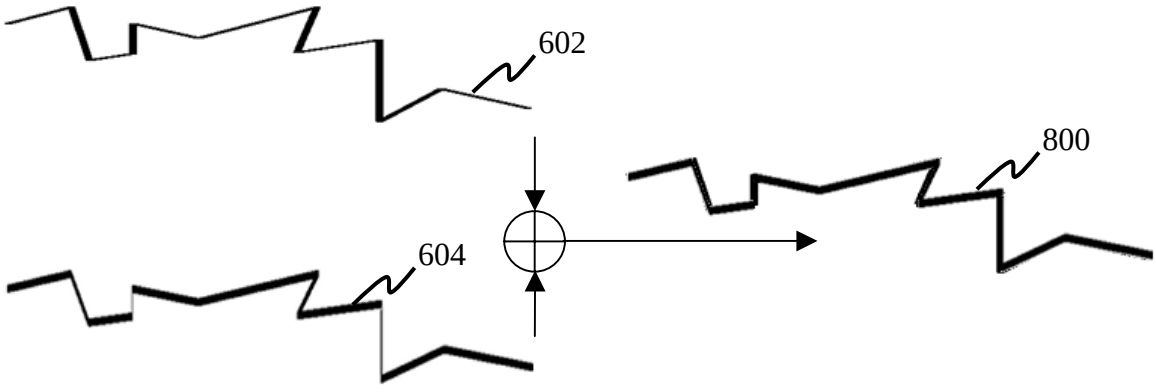

602
800
604

Fig. 8

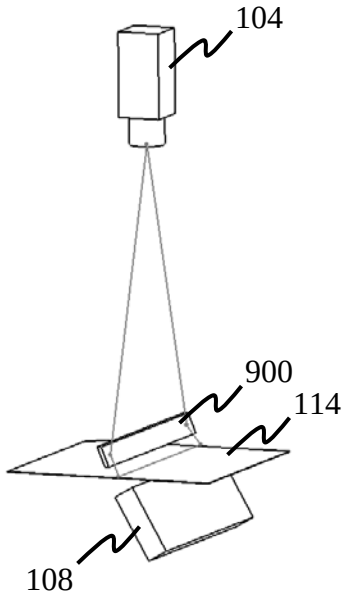


Fig. 9

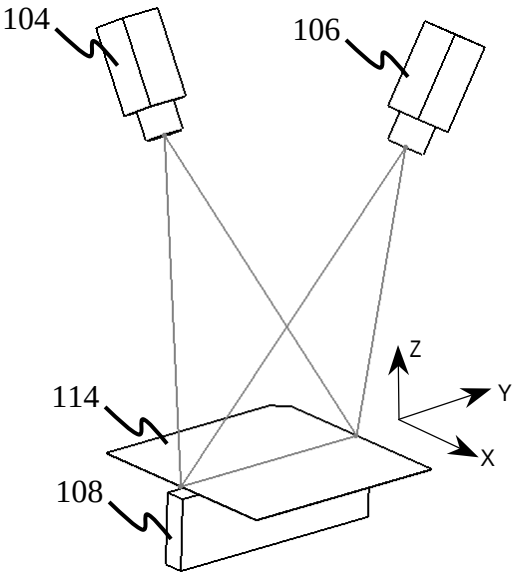


Fig. 10

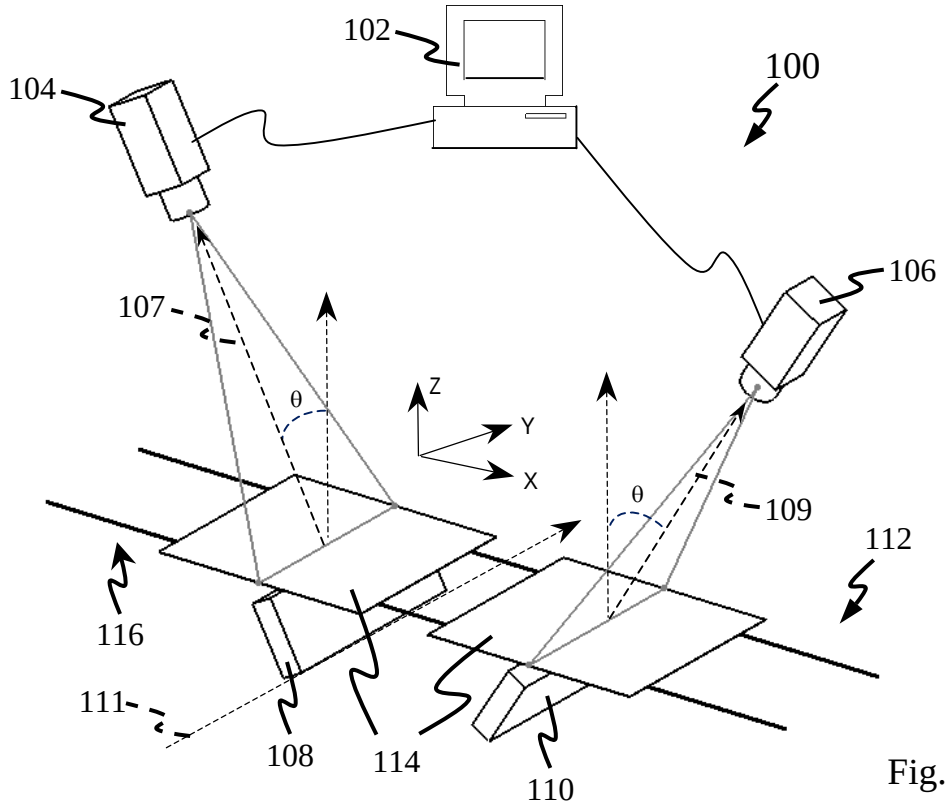

102
100
104
106
107
θ
Z
Y
X
θ
109
112
116
111
108
114
110

Fig. 11

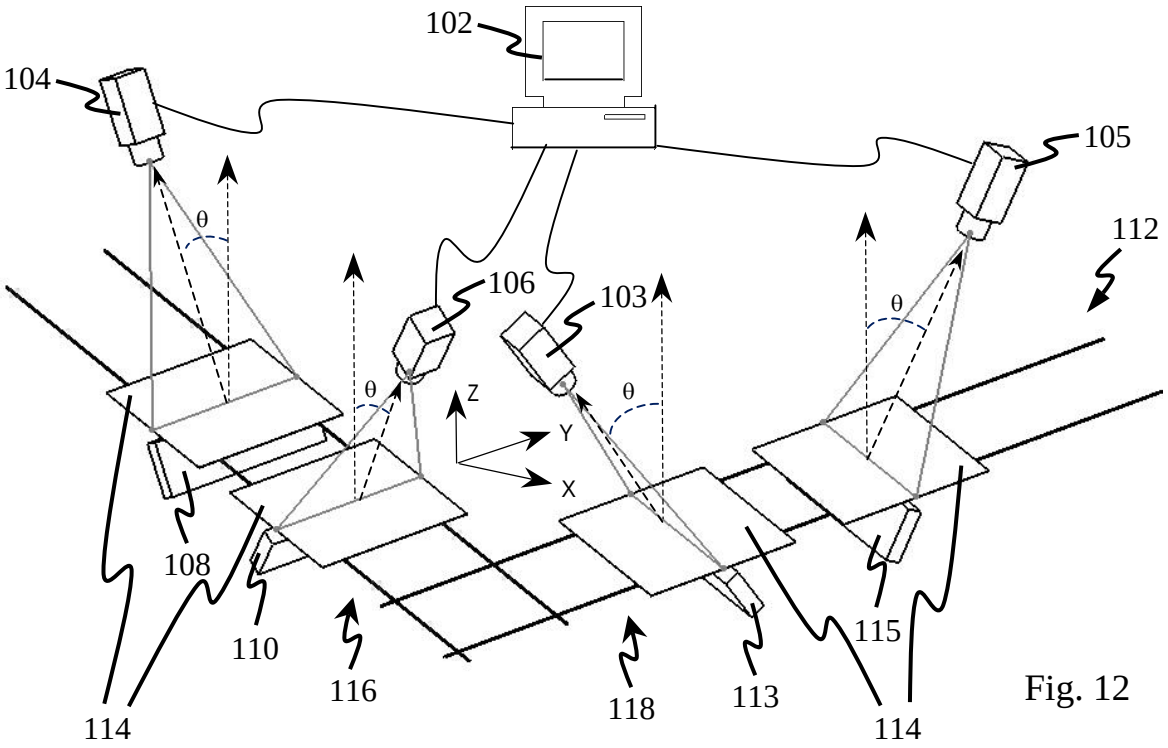

102
104
105
θ
112
106
103
θ
θ
Z
Y
X
108
110
116
118
113
115
114
114

Fig. 12